

# SN54ABT853, SN74ABT853 8-BIT TO 9-BIT PARITY BUS TRANSCEIVERS

SCBS198F – FEBRUARY 1991 – REVISED OCTOBER 1997

- State-of-the-Art **EPIC-II<sup>TM</sup>** BiCMOS Design Significantly Reduces Power Dissipation
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- Typical  $V_{OLP}$  (Output Ground Bounce) < 1 V at  $V_{CC} = 5$  V,  $T_A = 25^\circ\text{C}$
- High-Drive Outputs (–32-mA  $I_{OH}$ , 64-mA  $I_{OL}$ )
- High-Impedance State During Power Up and Power Down
- Parity-Error Flag With Parity Generator/Checker
- Latch for Storage of Parity-Error Flag
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) Packages, Ceramic Chip Carriers (FK), Ceramic Flat (W) Package, and Plastic (NT) and Ceramic (JT) DIPs

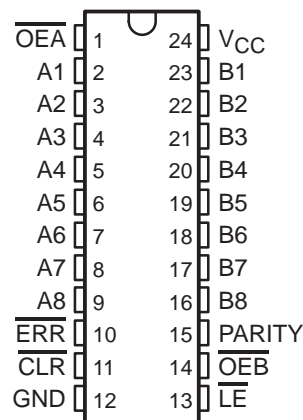
## description

The 'ABT853 8-bit to 9-bit parity transceivers are designed for communication between data buses. When data is transmitted from the A bus to the B bus, a parity bit is generated. When data is transmitted from the B bus to the A bus with its corresponding parity bit, the open-collector parity-error (ERR) output indicates whether or not an error in the B data has occurred. The output-enable ( $\overline{OEA}$  and  $\overline{OEB}$ ) inputs can be used to disable the device so that the buses are effectively isolated. The 'ABT853 transceivers provide true data at their outputs.

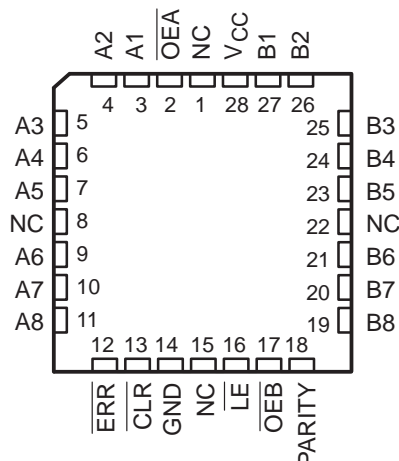
A 9-bit parity generator/checker generates a parity-odd (PARITY) output and monitors the parity of the I/O ports with the ERR flag. The parity-error output can be passed, sampled, stored, or cleared from the latch using the latch-enable ( $\overline{LE}$ ) and clear ( $\overline{CLR}$ ) control inputs. When both  $\overline{OEA}$  and  $\overline{OEB}$  are low, data is transferred from the A bus to the B bus and inverted parity is generated. Inverted parity is a forced error condition that gives the designer more system diagnostic capability.

When  $V_{CC}$  is between 0 and 2.1 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 2.1 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

SN54ABT853 . . . JT OR W PACKAGE  
SN74ABT853 . . . DB, DW, NT, OR PW PACKAGE  
(TOP VIEW)



SN54ABT853 . . . FK PACKAGE  
(TOP VIEW)



NC – No internal connection



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SN54ABT853, SN74ABT853  
8-BIT TO 9-BIT PARITY BUS TRANSCEIVERS

SCBS198F – FEBRUARY 1991 – REVISED OCTOBER 1997

description (continued)

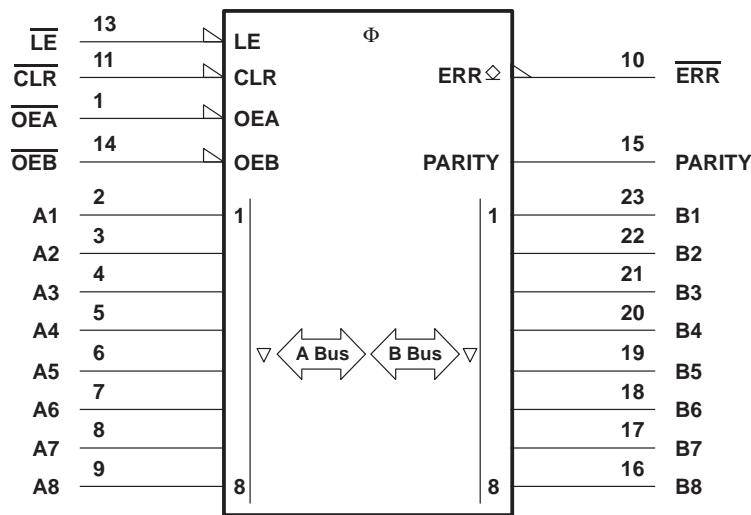
The SN54ABT853 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74ABT853 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE

| INPUTS                  |                         |                         |    |                              |                                      | OUTPUTS AND I/Os |    |        |                                  | FUNCTION  |
|-------------------------|-------------------------|-------------------------|----|------------------------------|--------------------------------------|------------------|----|--------|----------------------------------|---|
| $\overline{\text{OEB}}$ | $\overline{\text{OEA}}$ | $\overline{\text{CLR}}$ | LE | $\text{Ai}$<br>$\Sigma$ OF H | $\text{Bi}^\dagger$<br>$\Sigma$ OF H | A                | B  | PARITY | $\overline{\text{ERR}}^\ddagger$ |   |
| L                       | H                       | X                       | X  | Odd<br>Even                  | NA                                   | NA               | A  | L<br>H | NA                               | A data to B bus and<br>generate parity          |
| H                       | L                       | X                       | L  | NA                           | Odd<br>Even                          | B                | NA | NA     | H<br>L                           | B data to A bus and<br>check parity             |
| H                       | L                       | H                       | H  | NA                           | X                                    | X                | NA | NA     | NC                               | Store error flag                                |
| X                       | X                       | L                       | H  | X                            | X                                    | X                | NA | NA     | H                                | Clear error flag register                       |
| H                       | H                       | H                       | H  | X                            | X                                    | Z                | Z  | Z      | NC                               | Isolation§<br>(parity check)                    |
|                         |                         | L                       | H  | X                            |                                      |                  |    |        | H                                |   |
|                         |                         | X                       | L  | L Odd<br>H Even              |                                      |                  |    |        | H<br>L                           |   |
| L                       | L                       | X                       | X  | Odd<br>Even                  | NA                                   | NA               | A  | H<br>L | NA                               | A data to B bus and<br>generate inverted parity |

NA = not applicable, NC = no change, X = don't care  
† Summation of high-level inputs includes PARITY along with Bi inputs.  
‡ Output states shown assume ERR was previously high.  
§ In this mode, ERR (when clocked) shows inverted parity of the A bus.

logic symbol¶

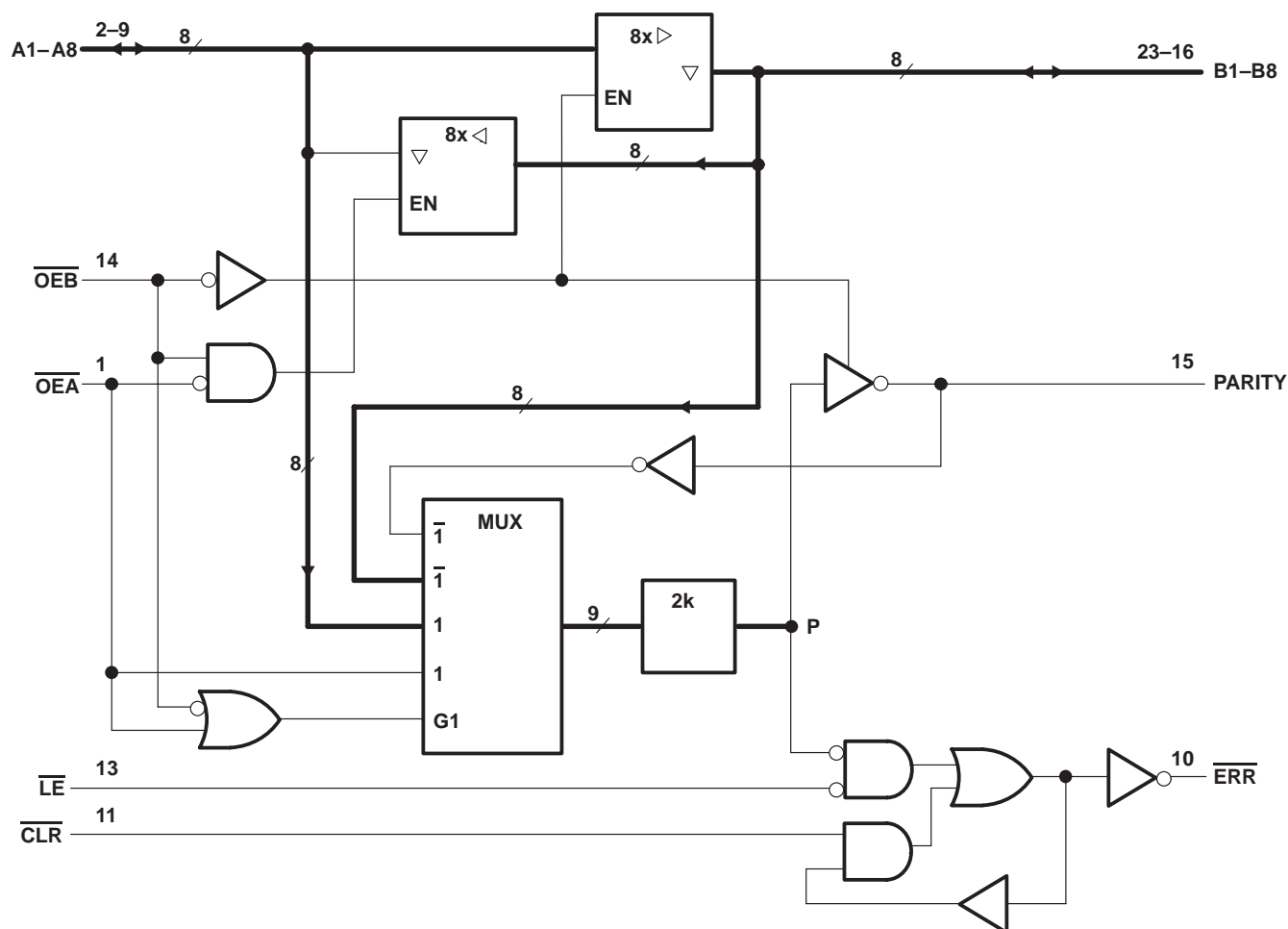


¶ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.  
Pin numbers shown are for the DB, DW, JT, NT, PW, and W packages.

# SN54ABT853, SN74ABT853 8-BIT TO 9-BIT PARITY BUS TRANSCEIVERS

SCBS198F – FEBRUARY 1991 – REVISED OCTOBER 1997

## logic diagram (positive logic)



Pin numbers shown are for the DB, DW, JT, NT, PW, and W packages.

ERROR-FLAG FUNCTION TABLE

| INPUTS |    | INTERNAL TO DEVICE | OUTPUT PRESTATE                 | OUTPUT ERR | FUNCTION |
|--------|----|--------------------|---------------------------------|------------|----------|
| CLR    | LE | POINT P            | ERR <sub>N-1</sub> <sup>†</sup> |            |          |
| L      | L  | L                  | X                               | L          | Pass     |
|        |    | H                  | X                               | H          |          |
| H      | L  | L                  | X                               | L          | Sample   |
|        |    | H                  | H                               | H          |          |
| L      | H  | X                  | X                               | H          | Clear    |
| H      | H  | X                  | L                               | L          | Store    |
|        |    |                    | H                               | H          |          |

<sup>†</sup> The state of ERR before changes at CLR, LE, or point P

## SCBS198F – FEBRUARY 1991 – REVISED OCTOBER 1997

Timing diagram for the 74VHC163 4-bit binary counter. The diagram shows the waveforms for OEB, OEA, Bi + PARITY, LE, CLR, and ERR signals over time. The OEB and OEA signals are active-low and remain high. The Bi + PARITY signal is a square wave. The LE signal is active-low and goes low during the 'Store' phase. The CLR signal is active-low and goes low during the 'Clear' phase. The ERR signal is active-low and goes low during the 'Pass' phase. The diagram is divided into three phases: Pass, Store, and Sample. The 'Pass' phase is marked by a double-headed arrow. The 'Store' phase is marked by a double-headed arrow. The 'Sample' phase is marked by a double-headed arrow. The 'Clear' phase is marked by a double-headed arrow.

|   |            |                 |
|---|------------|-----------------|
| Supply voltage range, $V_{CC}$  | .....      | -0.5 V to 7 V   |
| Input voltage range, $V_I$ : Except I/O ports (see Note 1)                | .....      | -0.5 V to 7 V   |
| Voltage range applied to any output in the high or power-off state, $V_O$ | .....      | -0.5 V to 5.5 V |
| Current into any output in the low state, $I_O$ : SN54ABT853              | .....      | 96 mA           |
|   | SN74ABT853 | 128 mA          |
| Input clamp current, $I_{IK}$ ( $V_I < 0$ )                               | .....      | -18 mA          |
| Output clamp current, $I_{OK}$ ( $V_O < 0$ )                              | .....      | -50 mA          |
| Package thermal impedance, $\theta_{JA}$ (see Note 2): DB package         | .....      | 104°C/W         |
|   | DW package | 81°C/W          |
|   | N package  | 67°C/W          |
|   | PW package | 120°C/W         |
| Storage temperature range, $T_{stg}$                                      | .....      | -65°C to 150°C  |

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JEDEC 51, except for through-hole packages, which use a trace length of zero.

# SN54ABT853, SN74ABT853 8-BIT TO 9-BIT PARITY BUS TRANSCEIVERS

SCBS198F – FEBRUARY 1991 – REVISED OCTOBER 1997

## recommended operating conditions (see Note 3)

|                          |                                    | SN54ABT853                     |                 | SN74ABT853 |                 | UNIT |
|--------------------------|------------------------------------|--------------------------------|-----------------|------------|-----------------|------|
|                          |                                    | MIN                            | MAX             | MIN        | MAX             |      |
| V <sub>CC</sub>          | Supply voltage                     | 4.5                            | 5.5             | 4.5        | 5.5             | V    |
| V <sub>IH</sub>          | High-level input voltage           | 2                              |                 | 2          |                 | V    |
| V <sub>IL</sub>          | Low-level input voltage            |                                | 0.8             |            | 0.8             | V    |
| V <sub>I</sub>           | Input voltage                      | 0                              | V <sub>CC</sub> | 0          | V <sub>CC</sub> | V    |
| V <sub>OH</sub>          | High-level output voltage          | $\overline{\text{ERR}}$        |                 | 5.5        |                 | V    |
| I <sub>OH</sub>          | High-level output current          | Except $\overline{\text{ERR}}$ |                 | –24        |                 | mA   |
| I <sub>OL</sub>          | Low-level output current           |                                |                 | 48         |                 | mA   |
| $\Delta t/\Delta v$      | Input transition rise or fall rate | Outputs enabled                |                 | 10         |                 | ns/V |
| $\Delta t/\Delta V_{CC}$ | Power-up ramp rate                 | 200                            |                 | 200        |                 | μs/V |
| T <sub>A</sub>           | Operating free-air temperature     | –55                            | 125             | –40        | 85              | °C   |

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.

# SN54ABT853, SN74ABT853

## 8-BIT TO 9-BIT PARITY BUS TRANSCEIVERS

SCBS198F – FEBRUARY 1991 – REVISED OCTOBER 1997

**electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)**

| PARAMETER           |  | TEST CONDITIONS   |                          | T <sub>A</sub> = 25°C |      |       | SN54ABT853 |       | SN74ABT853 |       | UNIT |
|---------------------|--|---|--------------------------|-----------------------|------|-------|------------|-------|------------|-------|------|
|                     |  |   |                          | MIN                   | TYP† | MAX   | MIN        | MAX   | MIN        | MAX   |      |
| V <sub>IK</sub>     |  | V <sub>CC</sub> = 4.5 V, I <sub>I</sub> = -18 mA  |                          |                       |      | -1.2  |            | -1.2  |            | -1.2  | V    |
| V <sub>OH</sub>     | All outputs except $\overline{\text{ERR}}$ | V <sub>CC</sub> = 4.5 V, I <sub>OH</sub> = -3 mA  |                          | 2.5                   |      |       | 2.5        |       | 2.5        |       | V    |
|                     |  | V <sub>CC</sub> = 5 V, I <sub>OH</sub> = -3 mA  |                          | 3                     |      |       | 3          |       | 3          |       |      |
|                     |  | V <sub>CC</sub> = 4.5 V   | I <sub>OH</sub> = -24 mA | 2                     |      |       | 2          |       |            |       |      |
|                     |  |   | I <sub>OH</sub> = -32 mA | 2*                    |      |       |            |       | 2          |       |      |
| V <sub>OL</sub>     |  | V <sub>CC</sub> = 4.5 V   | I <sub>OL</sub> = 24 mA  |                       |      | 0.55  |            | 0.55  |            |       | V    |
|                     |  |   | I <sub>OL</sub> = 64 mA  |                       |      | 0.55* |            |       |            | 0.55  |      |
| V <sub>hys</sub>    |  |   |                          |                       | 100  |       |            |       |            |       | mV   |
| I <sub>OH</sub>     | $\overline{\text{ERR}}$                    | V <sub>CC</sub> = 4.5 V, V <sub>OH</sub> = 5.5 V  |                          |                       |      | 50    |            | 50    |            | 50    | μA   |
| I <sub>I</sub>      | Control inputs                             | V <sub>CC</sub> = 5.5 V, V <sub>I</sub> = V <sub>CC</sub> or GND                          |                          |                       |      | ±1    |            | ±1    |            | ±1    | μA   |
|                     | A or B ports                               |   |                          |                       |      | ±100  |            | ±100  |            | ±100  |      |
| I <sub>OZPU</sub> ‡ |  | V <sub>CC</sub> = 0 to 2.1 V, V <sub>O</sub> = 0.5 V to 2.7 V, $\overline{\text{OE}}$ = X |                          |                       |      | ±50   |            | ±50   |            | ±50   | μA   |
| I <sub>OZPD</sub> ‡ |  | V <sub>CC</sub> = 2.1 V to 0, V <sub>O</sub> = 0.5 V to 2.7 V, $\overline{\text{OE}}$ = X |                          |                       |      | ±50   |            | ±50   |            | ±50   | μA   |
| I <sub>OZH</sub> §  |  | V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.7 V   |                          |                       |      | 10    |            | 10    |            | 10    | μA   |
| I <sub>OZL</sub> §  |  | V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 0.5 V   |                          |                       |      | -10   |            | -10   |            | -10   | μA   |
| I <sub>off</sub>    |  | V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> ≤ 4.5 V                             |                          |                       |      | ±100  |            |       |            | ±100  | μA   |
| I <sub>CEX</sub>    |  | V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 5.5 V   | Outputs high             |                       |      | 50    |            | 50    |            | 50    | μA   |
| I <sub>O</sub> ¶    |  | V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 2.5 V   |                          | -50                   | -100 | -200# | -50        | -200# | -50        | -200# | mA   |
| I <sub>CC</sub>     | A or B ports                               | V <sub>CC</sub> = 5.5 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND      | Outputs high             |                       | 1    | 250   |            | 450   |            | 250   | μA   |
|                     |  |   | Outputs low              |                       | 24   | 38    |            | 38    |            | 38    | mA   |
|                     |  |   | Outputs disabled         |                       | 0.5  | 250   |            | 450   |            | 250   | μA   |
| ΔI <sub>CC</sub>    | Data inputs                                | V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND       | Outputs enabled          |                       |      | 1.5   |            | 1.5   |            | 1.5   | mA   |
|                     |  |   | Outputs disabled         |                       |      | 50    |            | 50    |            | 50    | μA   |
|                     | Control inputs                             | V <sub>CC</sub> = 5.5 V, One input at 3.4 V, Other inputs at V <sub>CC</sub> or GND       |                          |                       |      | 1.5   |            | 1.5   |            | 1.5   | mA   |
| C <sub>i</sub>      | Control inputs                             | V <sub>I</sub> = 2.5 V or 0.5 V   |                          |                       |      | 4.5   |            |       |            |       | pF   |
| C <sub>io</sub>     | A or B ports                               | V <sub>O</sub> = 2.5 V or 0.5 V   |                          |                       |      | 10.5  |            |       |            |       | pF   |

\* On products compliant to MIL-PRF-38535, this parameter does not apply.

† All typical values are at V<sub>CC</sub> = 5 V.

‡ This parameter is characterized, but not production tested.

§ The parameters I<sub>OZH</sub> and I<sub>OZL</sub> include the input leakage current.

¶ Not more than one output should be tested at a time, and the duration of the test should not exceed one second.

# This data sheet limit can vary among suppliers.

|| This is the increase in supply current for each input that is at the specified TTL voltage level rather than V<sub>CC</sub> or GND.



# SN54ABT853, SN74ABT853 8-BIT TO 9-BIT PARITY BUS TRANSCEIVERS

SCBS198F – FEBRUARY 1991 – REVISED OCTOBER 1997

timing requirements over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

|          |                |   | $V_{CC} = 5\text{ V}$ ,<br>$T_A = 25^\circ\text{C}$ |     | SN54ABT853 |     | SN74ABT853       |     | UNIT |
|----------|----------------|---|---|-----|------------|-----|------------------|-----|------|
|          |                |   | MIN   | MAX | MIN        | MAX | MIN              | MAX |      |
| $t_W$    | Pulse duration | $\overline{LE}$ high or low                       | 3.5   |     | 3.5        |     | 3.5              |     | ns   |
|          |                | $\overline{CLR}$ low                              | 4   |     | 4          |     | 4                |     |      |
| $t_{su}$ | Setup time     | B or PARITY before $\overline{LE}\downarrow$      | 9.4 <sup>†</sup>                                    |     | 10.2       |     | 9.4 <sup>†</sup> |     | ns   |
|          |                | $\overline{CLR}$ before $\overline{LE}\downarrow$ | 2   |     | 2          |     | 2                |     |      |
| $t_h$    | Hold time      | B or PARITY after $\overline{LE}\downarrow$       | 0   |     | 0          |     | 0                |     | ns   |
|          |                | $\overline{CLR}$ after $\overline{LE}\downarrow$  | 3   |     | 3          |     | 3                |     |      |

<sup>†</sup> This data sheet limit can vary among suppliers.

switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

| PARAMETER | FROM<br>(INPUT)  | TO<br>(OUTPUT)   | $V_{CC} = 5\text{ V}$ ,<br>$T_A = 25^\circ\text{C}$ |     |                  | SN54ABT853       |      | SN74ABT853       |                  | UNIT |
|-----------|------------------|------------------|---|-----|------------------|------------------|------|------------------|------------------|------|
|           |                  |                  | MIN   | TYP | MAX              | MIN              | MAX  | MIN              | MAX              |      |
| $t_{PLH}$ | A or B           | B or A           | 1.2   |     | 4.8              | 1.2              | 6.4  | 1.2              | 5.3              | ns   |
| $t_{PHL}$ |                  |                  | 1   |     | 4.8 <sup>†</sup> | 1                | 5.4  | 1                | 5.3 <sup>†</sup> |      |
| $t_{PLH}$ | A                | PARITY           | 2.1   |     | 9.5              | 2.1              | 13.3 | 2.1              | 11.2             | ns   |
| $t_{PHL}$ |                  |                  | 2.5   |     | 9.7              | 2.5              | 11   | 2.5              | 11               |      |
| $t_{PLH}$ | $\overline{OE}$  | PARITY           | 1.8   |     | 8.5              | 1.8              | 13.6 | 1.8              | 10.5             | ns   |
| $t_{PHL}$ |                  |                  | 2.3   |     | 8.6              | 2.3              | 11.7 | 2.3              | 10               |      |
| $t_{PLH}$ | $\overline{CLR}$ | $\overline{ERR}$ | 1   |     | 5.5              | 1                | 6.3  | 1                | 6.2              | ns   |
| $t_{PLH}$ | $\overline{LE}$  | ERR              | 1.8   |     | 5.1              | 1.8              | 6.1  | 1.8              | 6                | ns   |
| $t_{PHL}$ |                  |                  | 1 <sup>†</sup>                                      |     | 5.8              | 1 <sup>†</sup>   | 6.7  | 1                | 6.6              |      |
| $t_{PLH}$ | B or PARITY      | ERR              | 2   |     | 10.1             | 2                | 11.8 | 2                | 11.7             | ns   |
| $t_{PHL}$ |                  |                  | 2.2 <sup>†</sup>                                    |     | 11.5             | 2.2 <sup>†</sup> | 12.9 | 2.2 <sup>†</sup> | 12.8             |      |
| $t_{PZH}$ | $\overline{OE}$  | A or B or PARITY | 1   |     | 5.8 <sup>†</sup> | 1                | 8.8  | 1                | 6.7 <sup>†</sup> | ns   |
| $t_{PZL}$ |                  |                  | 1.5 <sup>†</sup>                                    |     | 5.8              | 1.5 <sup>†</sup> | 9.8  | 1.5 <sup>†</sup> | 6.7              |      |
| $t_{PHZ}$ | $\overline{OE}$  | A or B or PARITY | 1.8 <sup>†</sup>                                    |     | 7.3              | 1.8 <sup>†</sup> | 9.5  | 1.8 <sup>†</sup> | 7.9              | ns   |
| $t_{PLZ}$ |                  |                  | 2.1 <sup>†</sup>                                    |     | 7.2              | 2.1 <sup>†</sup> | 8.2  | 2.1 <sup>†</sup> | 8.1              |      |

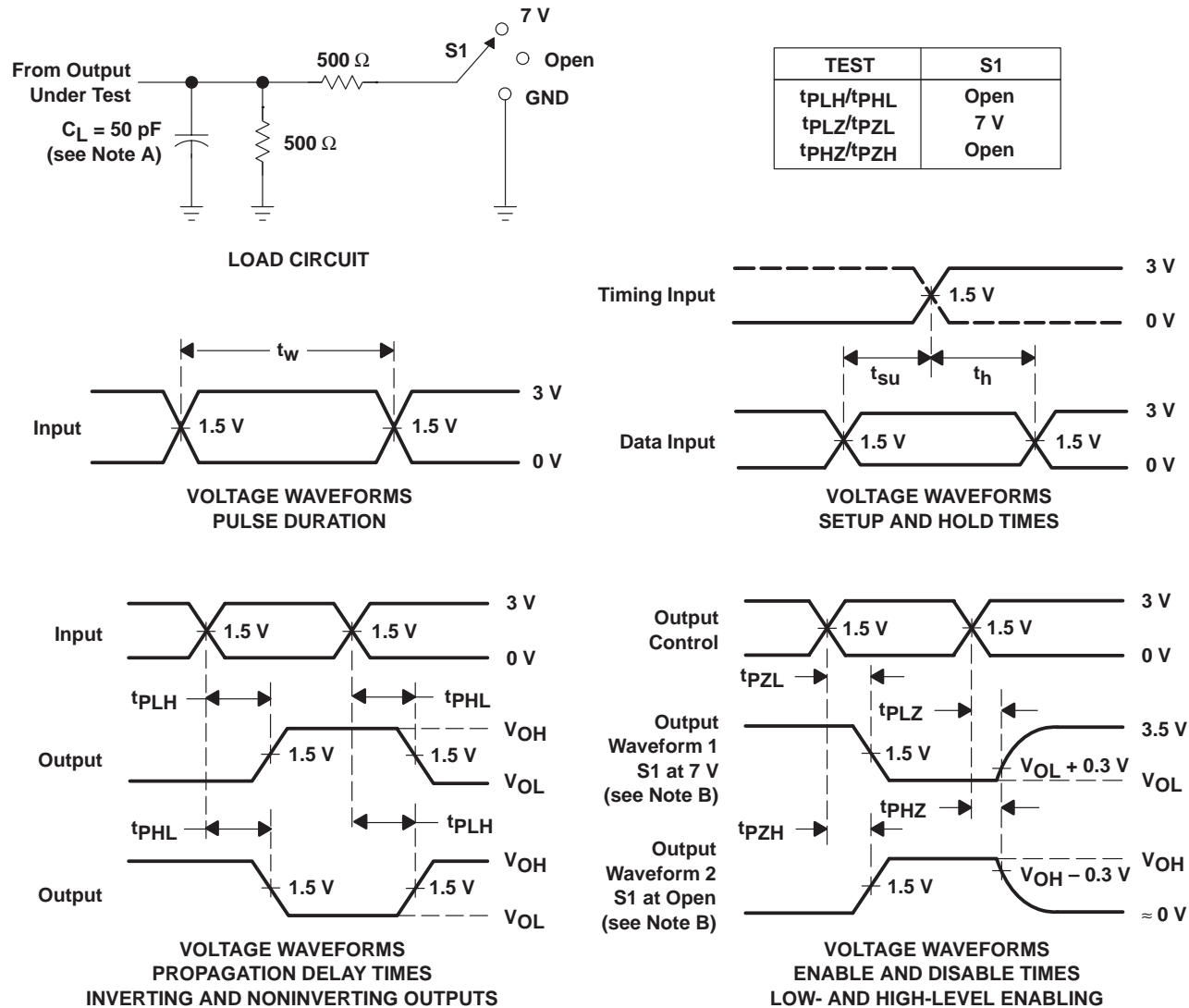
<sup>†</sup> This data sheet limit can vary among suppliers.



# SN54ABT853, SN74ABT853 8-BIT TO 9-BIT PARITY BUS TRANSCEIVERS

SCBS198F – FEBRUARY 1991 – REVISED OCTOBER 1997

## PARAMETER MEASUREMENT INFORMATION



- NOTES: A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10\text{ MHz}$ ,  $Z_O = 50\text{ }\Omega$ ,  $t_r \leq 2.5\text{ ns}$ ,  $t_f \leq 2.5\text{ ns}$ .
- D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



**PACKAGING INFORMATION**

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| 5962-9674601Q3A  | ACTIVE                | LCCC         | FK              | 28   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| 5962-9674601QKA  | ACTIVE                | CFP          | W               | 24   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| 5962-9674601QLA  | ACTIVE                | CDIP         | JT              | 24   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| SN74ABT853DBLE   | OBSOLETE              | SSOP         | DB              | 24   |             | TBD                     | Call TI          | Call TI                      |
| SN74ABT853DBRE4  | ACTIVE                | SSOP         | DB              | 24   |             | TBD                     | Call TI          | Call TI                      |
| SN74ABT853DBRG4  | ACTIVE                | SSOP         | DB              | 24   |             | TBD                     | Call TI          | Call TI                      |
| SN74ABT853DW     | ACTIVE                | SOIC         | DW              | 24   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ABT853DWE4   | ACTIVE                | SOIC         | DW              | 24   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ABT853DWG4   | ACTIVE                | SOIC         | DW              | 24   | 25          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ABT853DWR    | ACTIVE                | SOIC         | DW              | 24   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ABT853DWRE4  | ACTIVE                | SOIC         | DW              | 24   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ABT853DWRG4  | ACTIVE                | SOIC         | DW              | 24   | 2000        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN74ABT853NSRE4  | ACTIVE                | SO           | NS              | 24   |             | TBD                     | Call TI          | Call TI                      |
| SN74ABT853NSRG4  | ACTIVE                | SO           | NS              | 24   |             | TBD                     | Call TI          | Call TI                      |
| SN74ABT853NT     | ACTIVE                | PDIP         | NT              | 24   | 15          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN74ABT853NTE4   | ACTIVE                | PDIP         | NT              | 24   | 15          | Pb-Free (RoHS)          | CU NIPDAU        | N / A for Pkg Type           |
| SN74ABT853PWE4   | ACTIVE                | TSSOP        | PW              | 24   |             | TBD                     | Call TI          | Call TI                      |
| SN74ABT853PWG4   | ACTIVE                | TSSOP        | PW              | 24   |             | TBD                     | Call TI          | Call TI                      |
| SN74ABT853PWLE   | OBSOLETE              | TSSOP        | PW              | 24   |             | TBD                     | Call TI          | Call TI                      |
| SN74ABT853PWRE4  | ACTIVE                | TSSOP        | PW              | 24   |             | TBD                     | Call TI          | Call TI                      |
| SN74ABT853PWRG4  | ACTIVE                | TSSOP        | PW              | 24   |             | TBD                     | Call TI          | Call TI                      |
| SNJ54ABT853FK    | ACTIVE                | LCCC         | FK              | 28   | 1           | TBD                     | POST-PLATE       | N / A for Pkg Type           |
| SNJ54ABT853JT    | ACTIVE                | CDIP         | JT              | 24   | 1           | TBD                     | A42              | N / A for Pkg Type           |
| SNJ54ABT853W     | ACTIVE                | CFP          | W               | 24   | 1           | TBD                     | A42              | N / A for Pkg Type           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS

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compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74ABT853DWR | SOIC         | DW              | 24   | 2000 | 330.0              | 24.4               | 10.75   | 15.7    | 2.7     | 12.0    | 24.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74ABT853DWR | SOIC         | DW              | 24   | 2000 | 346.0       | 346.0      | 41.0        |

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

## FK (S-CQCC-N\*\*)

## LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a metal lid.
  - The terminals are gold plated.
  - Falls within JEDEC MS-004

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



| DIM \ PINS ** | 14    | 16    | 20    | 24    |
|---------------|-------|-------|-------|-------|
| A MAX         | 10,50 | 10,50 | 12,90 | 15,30 |
| A MIN         | 9,90  | 9,90  | 12,30 | 14,70 |

4040062/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## PW (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

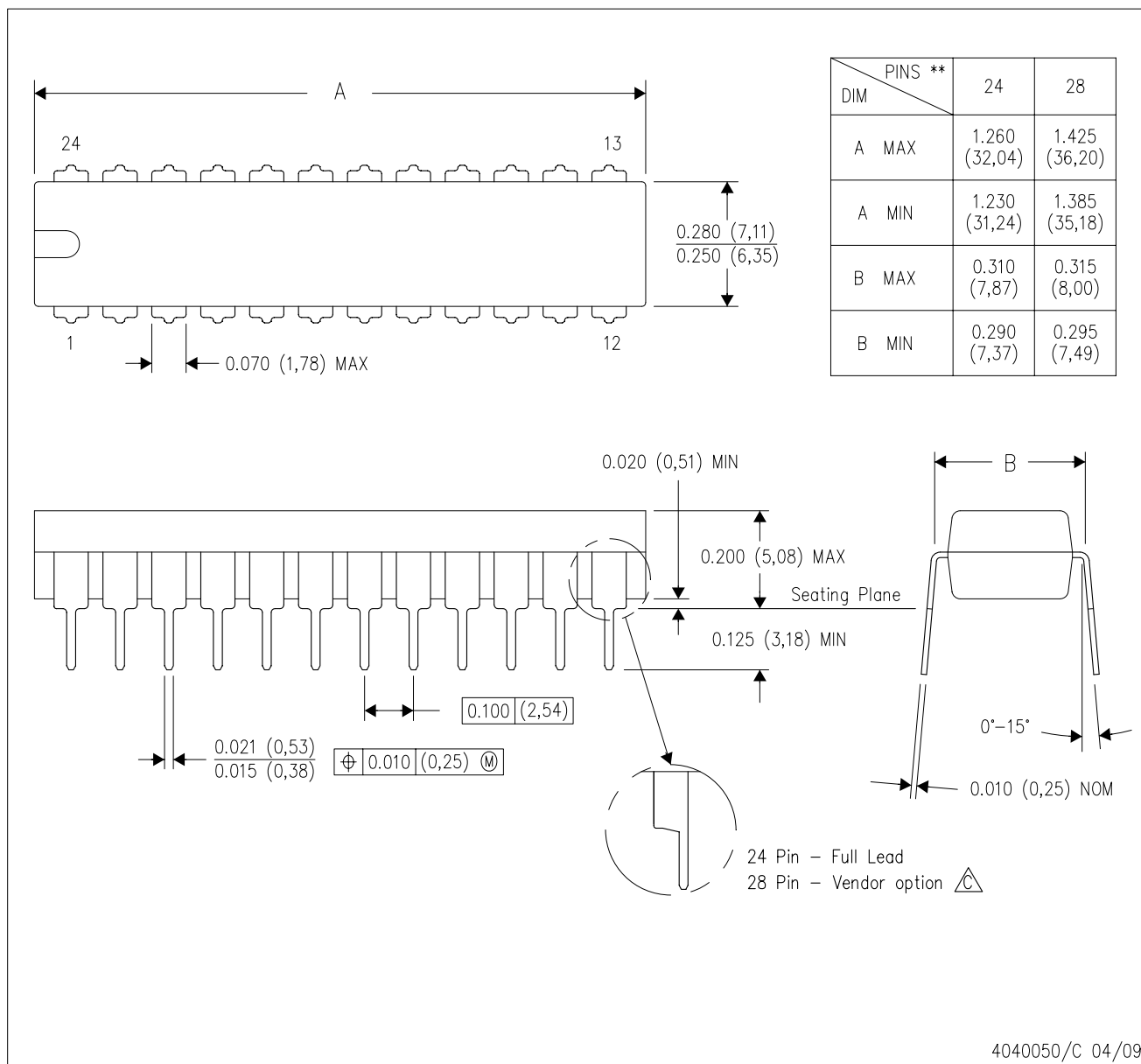


# MECHANICAL DATA

NT (R-PDIP-T\*\*)

24 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - $\triangle C$  The 28 pin end lead shoulder width is a vendor option, either half or full width.

## DW (R-PDSO-G24)

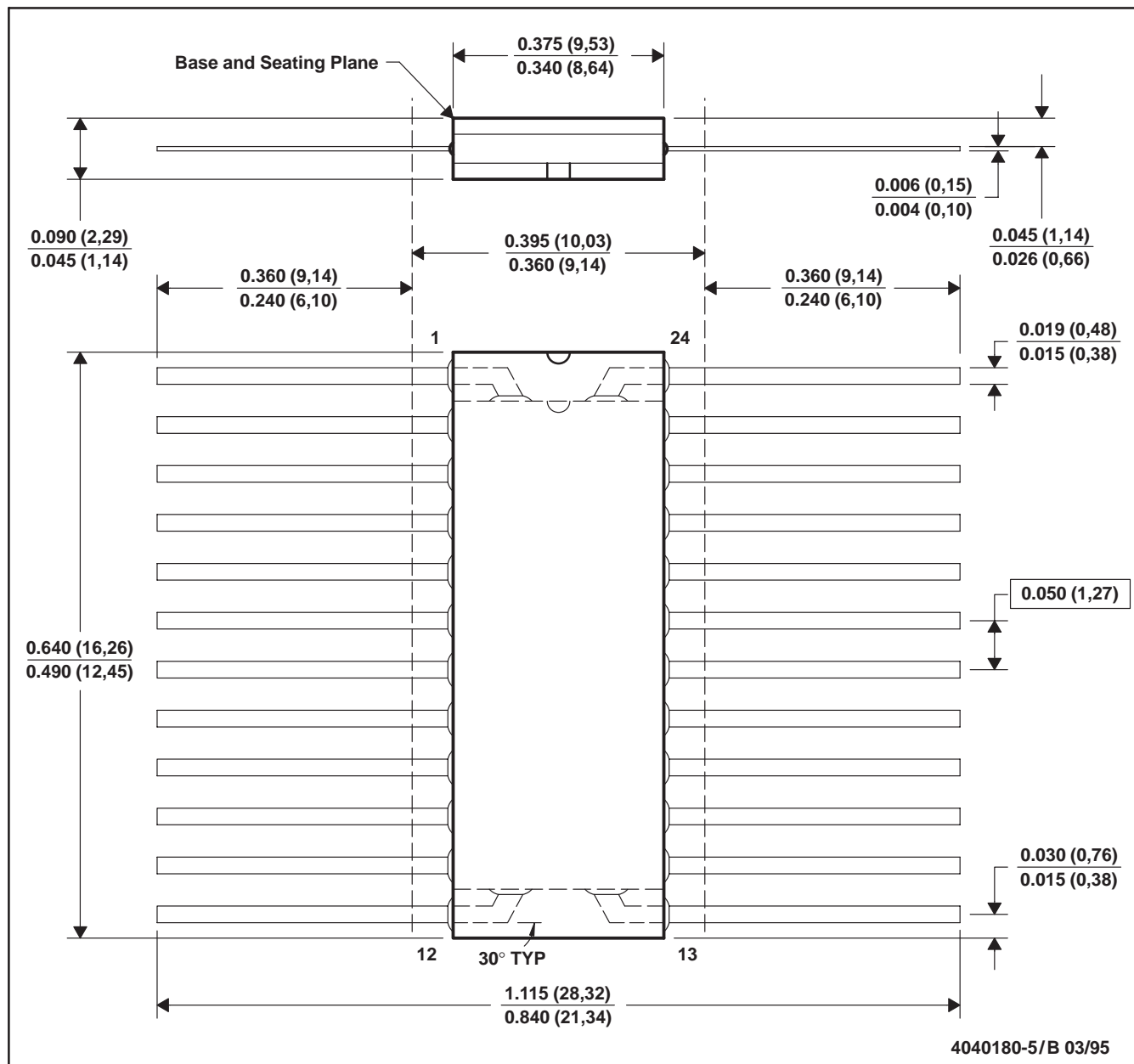
## PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - Falls within JEDEC MS-013 variation AD.

## W (R-GDFP-F24)

## CERAMIC DUAL FLATPACK



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a ceramic lid using glass frit.
  - Falls within MIL-STD-1835 GDFP2-F24 and JEDEC MO-070AD
  - Index point is provided on cap for terminal identification only.

## JT (R-GDIP-T\*\*)

## CERAMIC DUAL-IN-LINE

24 LEADS SHOWN



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification.
  - Falls within MIL STD 1835 GDIP3-T24, GDIP4-T28, and JEDEC MO-058 AA, MO-058 AB

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